

Helping Customers Innovate, Improve &amp; Grow


**OX-171**

The OX-171 is a high stability ovenized crystal oscillator in a 28 x 38 mm package, capable of aging rates of 0.06 ppb/day and temperature stabilities of 1ppb over an industrial temperature range. Driven by an SC-cut crystal, the oscillator provides excellent phase noise and Allan Deviation. The OX-171 is a member of the OX-17 series oscillators. Other oscillators in the series include the OX-170 standard oscillator, OX-172 optimized for 1588 solutions, and the OX-174 and OX-175 low phase noise oscillators. The Microsemi design team will also help develop custom solutions where performance optimization is required for specific applications. Please contact the factory for customization options.

### Features

- Reflow Process Compatible
- SC-Cut resonator
- Temperature stability to 0.4 ppb
- Aging rate options to 0.06 ppb/day
- Frequency Range 5 to 20 MHz
- Standard Frequencies: 5, 10, 12.8, 20 MHz

### Applications

- Holdover reference
- Test equipment
- Synthesizers
- Military communication equipment
- Digital Switching

### Performance Specifications

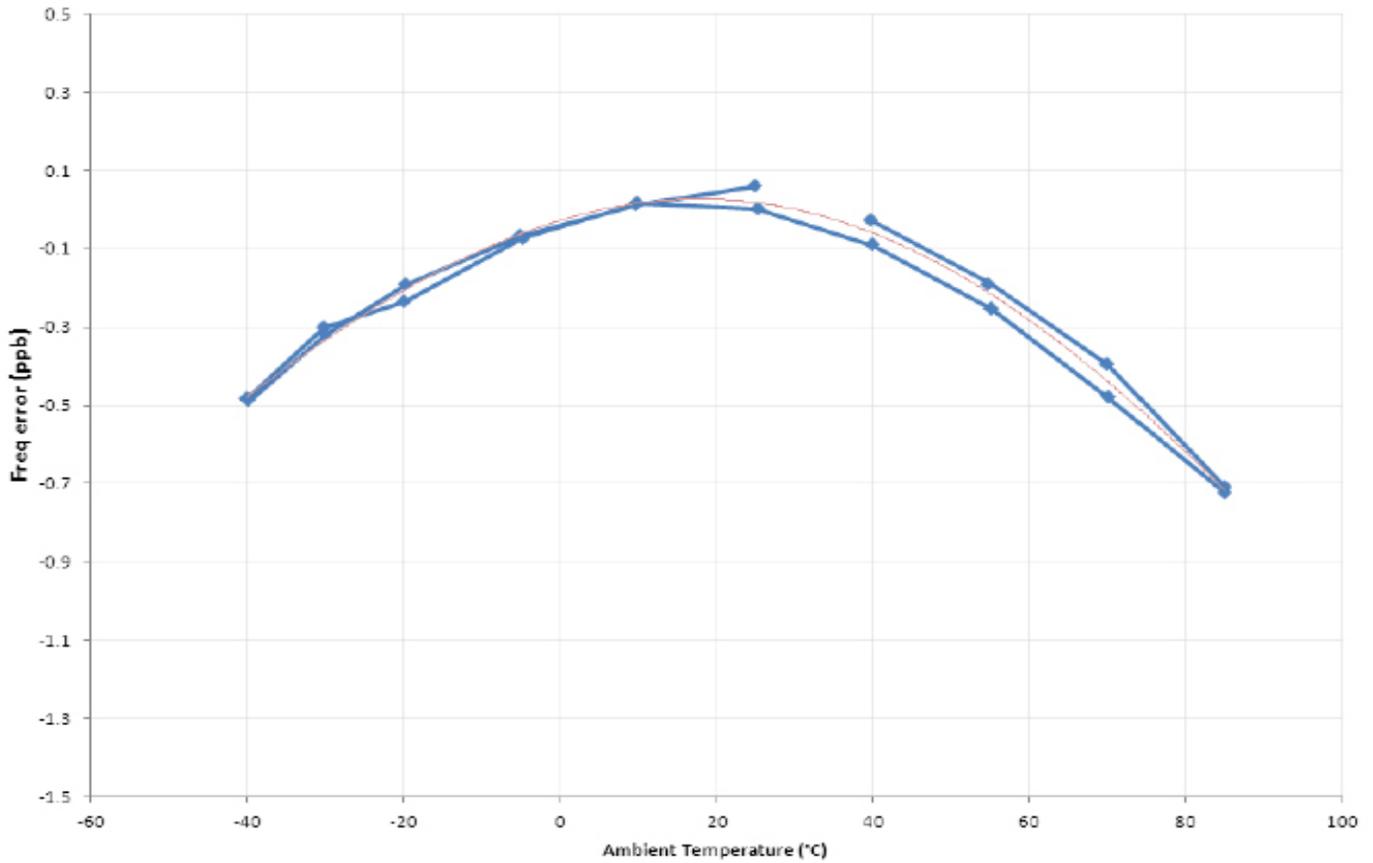
Frequency Stabilities <sup>1</sup>					
(Stabilities listed for 10 MHz, for stabilities above 10 MHz values may degrade, please contact factory)					
Parameter	Min	Typical	Max	Units	Condition
vs. operating temperature range (referenced to +25°C)	-0.4		+0.4	ppb	0 to +70°C
	-0.6		+0.6	ppb	-20 to +70°C
	-0.8		+0.8	ppb	-40 to +85°C
For better stability refer to the MX-060 or MX-041 datasheets					
Initial tolerance	-25		+25	ppb	at time of shipment, nominal EFC
vs. supply voltage change	-0.5		+0.5	ppb	V <sub>s</sub> ±5%
vs. load change	-0.2		+0.2	ppb	Load ±5%
vs. aging / day	-1		+1	ppb	after 24 hours operation
vs. aging / day	-0.1		+0.1	ppb	after 72 hours operation
vs.aging/day	-0.06		+0.06	ppb	after 7 days operation
vs. aging / year	-15		+15	ppb	after 72 hours operation
vs. aging / year (following year)	-10		+10	ppb	
vs. aging/ 10 years	-75		+75	ppb	after 72 hours operation
retrace <sup>2</sup>	-2		+2	ppb	
Warm-up time			5	minutes	to ±5 ppb of final frequency (1 hour reading) @ +25°C

## Performance Specifications

Supply Voltage (Vs)					
Parameter	Min	Typical	Max	Units	Condition
Supply Voltage (Vs)	3.135	3.3	3.465	VDC	Ordering Code E
	4.75	5.0	5.25	VDC	Ordering Code D
	11.4	12.0	12.6	VDC	Ordering code B , temp stability T and J only
Power Consumption			4	Watts	during warm-up, all temperatures
			1.5	Watts	steady state @ +25°C
		3.3		Watts	steady state @ -40°C
		0.5		Watts	steady state @ +85°C
RF Output					
start time		1	2	s	time required to achieve 90% of amplitude
Signal [standard]	HCMOS				
Load		15		pF	
Signal Level (Vol)			0.4	VDC	with Vs=3.3V and 15pF Load
			0.5	VDC	with Vs=5.0V & 12V and 15pF Load
Signal Level (Voh)	2.4			VDC	with Vs=3.3V and 15pF Load
	3.5				with Vs=5.0V & 12V and 15pF Load
Duty Cycle	45		55	%	@ (Voh-Vol)/2
Signal	Sine Wave				
Load		50		Ω	
Output Power @3,3V	2	5	8	dBm	
Output Power @ 5.0V,12 V	5	8	11	dBm	
Harmonics			-40	dBc	
Subharmonics			-40	dBc	frequencies >= 10 MHz
Frequency Tuning (EFC)					
Tuning Range	±125		±250	ppb	(fixed frequency option available)
Linearity		10		%	
Tuning Slope	Positive				
Input Impedance		100		kOhm	
Bandwidth Modulation	150			Hz	
Control Voltage Range	0.0	1.4	2.8	VDC	with Vs=3.3V
	0.0	2.0	4.0	VDC	with Vs=5.0V
	0.0	2.5	5	VDC	with Vs=12.0V
Reference Voltage Output (Vref)					
The OX-171 can be configured with a reference voltage, but requires the use of a six pin package. This configuration requires a custom part number, and may degradethe stability of the part. Please contact the factory for ordering information.					
Reference Voltage	2.75	2.8	2.85	VDC	with Vs = 3.3 VDC
	3.92	4.0	4.08	VDC	with Vs = 5.0 VDC
	4.9	5	5.1	VDC	with Vs =12 VDC

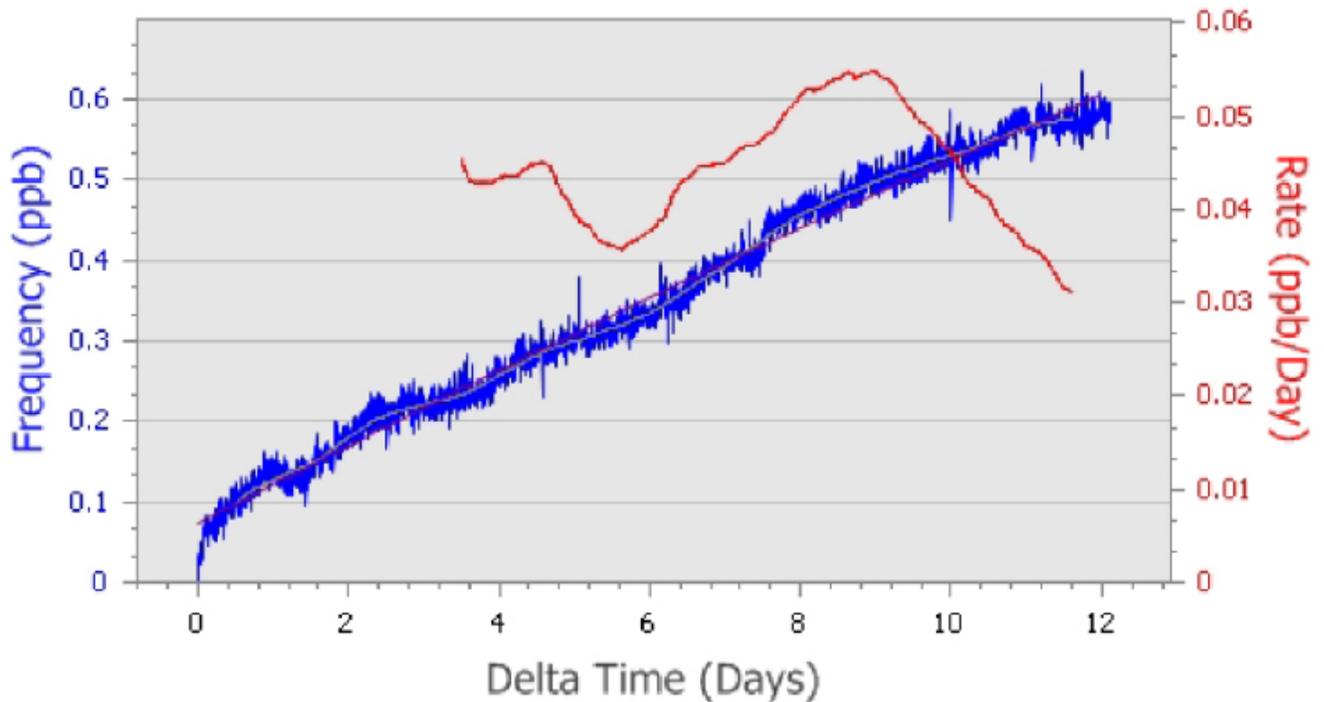
Additional Parameters						
Parameter	Min	Typical	Max	Units	Condition	
Phase Noise <sup>3</sup>			-95	dBc/Hz	1 Hz	
			-125	dBc/Hz	10 Hz	
			-140	dBc/Hz	100 Hz	
			-145	dBc/Hz	1 kHz	
			-145	dBc/Hz	10 kHz	
For lower phase please review the OX-174 datasheet.						
Allan deviation			5	E-12	1 s tau	
			8	E-12	10 s tau	
			1	E-11	100 s tau	
			5	E-11	1000 s tau	
For oscillators with low ADEV requirements please review the OX-174 datasheet. For oscillators with TDEV and MTIE requirements please review the OX-172 datasheet						
g-sensitivity				1	ppb/g	
g-sensitivity of 0.5 ppb/g available in this package size. Please contact factory for ordering information. For g sensitivity <0.1 ppb/g please review the OX-043 series.						
Weight			25	g		
Absolute Maximum Ratings						
Supply Voltage (Vs)			6.5	V	with Vs=3.3 & 5.0 VDC	
			15.0	V	with Vs= 12 VDC	
Output Load			50	pF		
Operable Temperature Range	-55		+95	°C	operable temperature range implies the device will continue to operate with no long-term damage to unit however it will not be specification compliant outside the operating temperature range	
Environmental and Product Classification						
Shock (Endurance)	MIL-STD-202, Method 213, Condition J, 30g 11 ms					
Sine Vibration (Endurance)	MIL-STD-202, Method 201 and 204, Condition A, except 5g to 500 Hz, 1 sweep each axis					
Random Vibration (Endurance)	MIL-STD-202, Method 214, Condition I-D					
Humidity	MIL-STD-202, Method 103, Condition B, 100% rh					
Seal	MIL-STD-202, Method 112, Condition D, hermetic, washable					
Altitude	MIL-STD-202, Method 105, sea level to space					
Resistance to Soldering Heat	MIL-STD-202, Method 210, Condition A,B,C					
Terminal Strength	MIL-STD-202, Method 211, Condition C (5 bends at 45°, 2 lbs)					
Moisture Sensitive Level	1					
RoHS	compliant with exemption 7c-i					
Storage Temperature Range	-55		+125	°C		

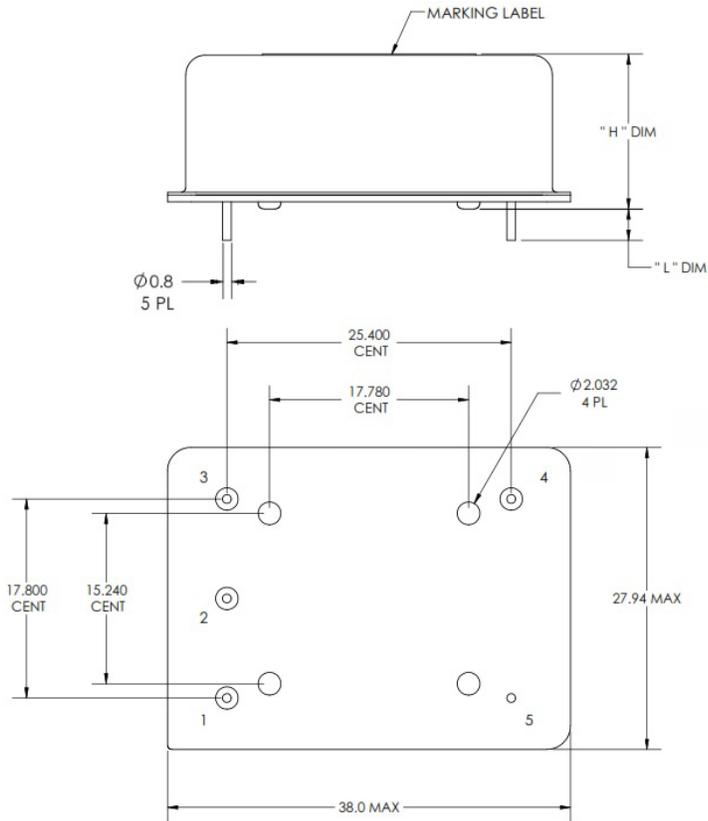
### OX-171 Frequency vs. Temperature



**Frequency vs Temperature Plot -  
Blue line - measured data-  
Red line - curve fit data.**

### OX-171 Aging

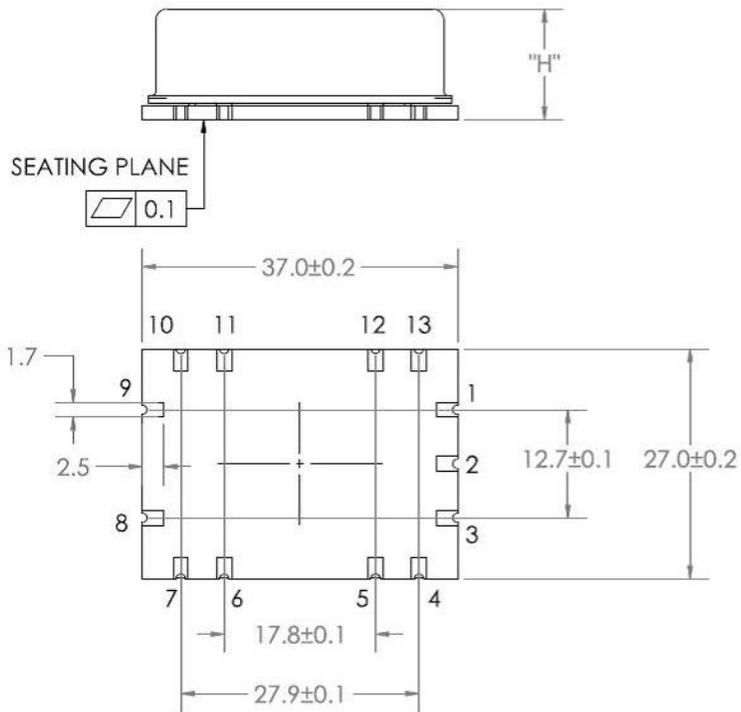




Through hole Package configuration A		
	Height "H"	Pin Length "L"
0	14	4.5 mm min
4	12.7	4.5 mm min

Pin Connections	
1	Electronic Frequency Control Input (EFC) No connect for fixed frequency oscillators
2	No Connect
3	Supply Voltage Input (VS)
4	RF Output
5	Ground (Case)

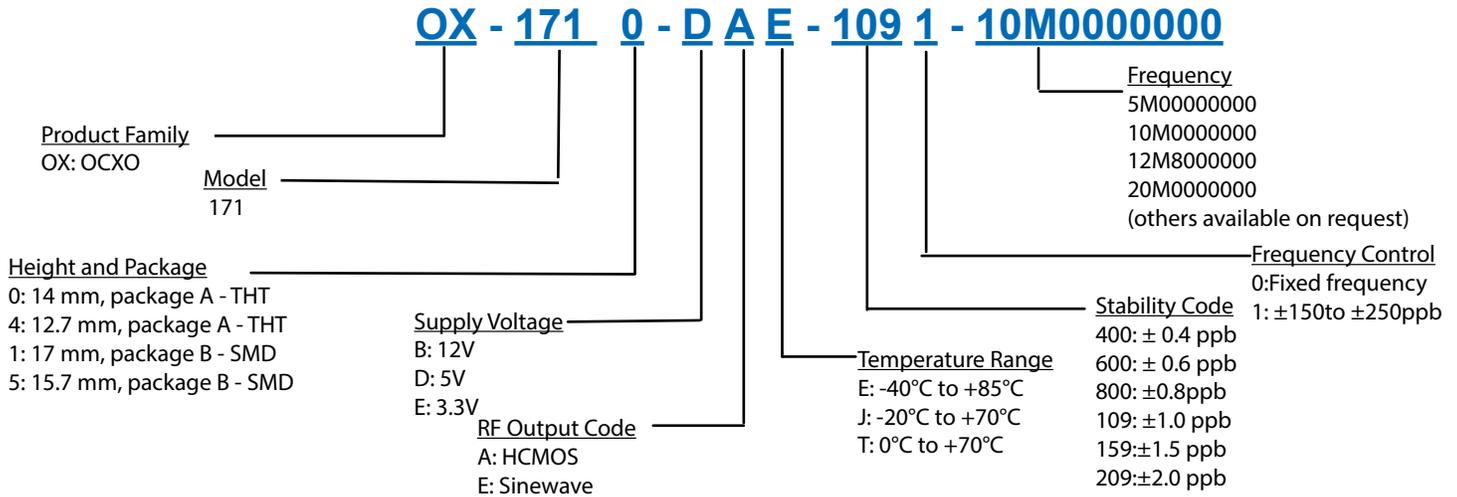
Dimensions in mm



SMD Package configuration 1	
	Height "H"
1	17
5	15.7

Pin Connections	
2,4,5,6,7, 11,12,13	No Connect
1	Electronic Frequency Control Input (EFC) No Connect for Fixed frequency Oscillators
3	Supply Voltage Input (Vs)
8	RF Output
9,10	Ground (Case)

## Ordering Information<sup>4</sup>



Stability code - Temperature and Frequency Options			
Frequency	0 to +70 °C	-20 to +70 °C	-40 to +85°C
5 to 10 MHz	400	600	800
> 10 MHz	109	159	209

## Additional Ordering Options

Additional ordering options available include custom heights, custom aging rates, custom temperature ranges, custom temperature stabilities, custom phase noise requirements, improved g-sensitivity, and oscillators with voltage reference output on pin 2. These modifications require a custom dash number - please contact the factory for additional information.

## Design Tools

Microsemi stocks the following items for small orders and prototype development:
OX-1710-DEE-8001-10M00000000
Microsemi stocks the following evaluation board for this product:
OCXO Evaluation Board
Application Notes:
None

### Notes:

1. Unless otherwise stated, all values are valid after warm-up time and refer to typical conditions for supply voltage, frequency control voltage, load, and temperature (25°C).
2. Retrace defined as f1-fo where fo is the reading after the unit has been on power for 24 hours, and f1 is the frequency after 24 hours off followed by 60 minutes on.
3. Phase noise degrades with increasing output frequency.
4. Not all options and codes available at all frequencies.



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